



- Low-loss 782 MHz SAW Filter
- · Designed for 50 ohm Source/Load
- Complies with Directive 2002/95/EC (RoHS)

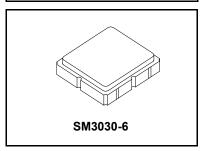


#### **Absolute Maximum Ratings**

Rating	Value	Units
Input Power Level	+25	dBm
DC Voltage on any Non-ground Terminal	3	V
Operating Temperature Range	-40 to +85	°C
Storage Temperature Range in Tape and Reel	-40 to +85	°C
Maximum Soldering Profile, 5 cycles/10 seconds maximum	265	°C

### **SF2315E**

### 782 MHz **SAW Filter**



#### **Electrical Characteristics**

Characteristic		Notes	Min	Тур	Max	Units
Center Frequency				782		MHz
Insertion Loss, 777 to 787 MHz	IL			2.2	3.0	dB
Bandwidth			10	25		MHz
Amplitude Ripple, 777 to 787 MHz				0.35	1.00	dB <sub>P-P</sub>
Attenuation, Referenced to 0 dB:						
300 to 700 MHz			28	61		dB
728 to 757 MHz			10	48		T UB
880 to 1050 MHz			28	61		1
Source Impedance				50		Ω
Load Impedance				50		Ω
Case Style	SM3030-6 3.0 x 3.0 mm Nominal Footprint					
Lid Symbolization (Y=year, WW=week, S=shift) dot=pin 1 indicator	A72, YWWS					
andard Reel Quantity Reel Size 7 inch 500 Pieces/Reel						
Reel Size 13 inch 3000 Pieces/Reel						

#### **Electrical Connections**

Connection	Terminals
Input	2
Output	5
Case Ground	All others

### CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

### Notes:

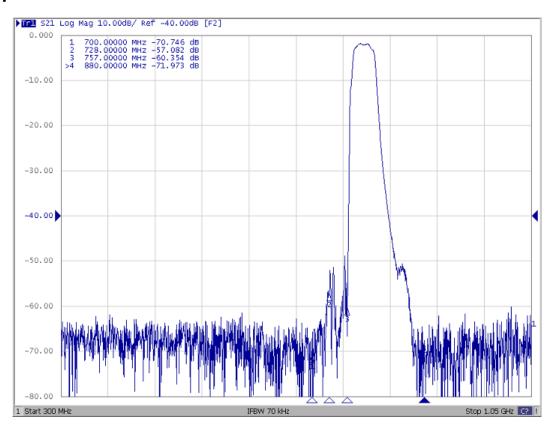
- Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50  $\Omega$  and measured with 50  $\Omega$  network analyzer. 1.
- Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc. 2. 3.
- Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.

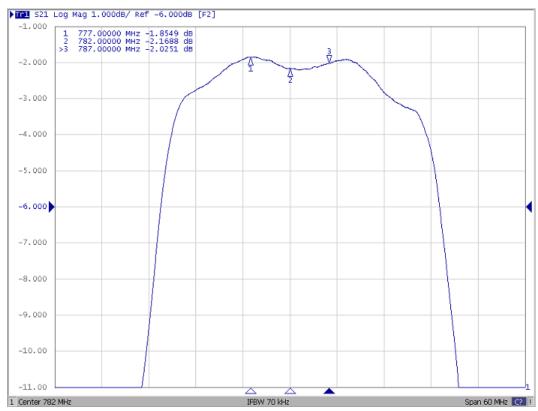
  "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."

  The design, manufacturing process, and specifications of this filter are subject to change.

  Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port
- 2, so that the filter must always be installed in one direction per the circuit design.
- US and international patents may apply.
  RFM, stylized RFM logo, and RF Monolithics, Inc. are registered trademarks of RF Monolithics, Inc.

### **Filter Response Plots**

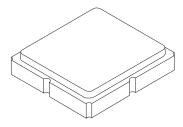


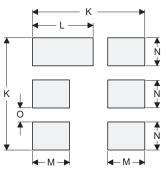


## **SM3030-6 Case**

### **6-Terminal Ceramic Surface-Mount Case** 3.0 X 3.0 mm Nominal Footprint







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**PCB Footprint Top View** 

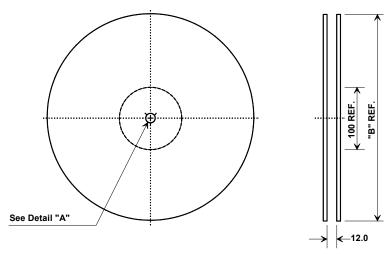
Dimension	mm			Inches		
Dimension	Min	Nom	Max	Min	Nom	Max
Α	2.87	3.00	3.13	0.113	0.118	0.123
В	2.87	3.00	3.13	0.113	0.118	0.123
С	1.12	1.25	1.38	0.044	0.049	0.054
D	0.77	0.90	1.03	0.030	0.035	0.040
E	2.67	2.80	2.93	0.105	0.110	0.115
F	1.47	1.60	1.73	0.058	0.063	0.068
G	0.72	0.85	0.98	0.028	0.033	0.038
Н	1.37	1.50	1.63	0.054	0.059	0.064
I	0.47	0.60	0.73	0.019	0.024	0.029
J	1.17	1.30	1.43	0.046	0.051	0.056
K		3.20			0.126	
L		1.70			0.067	
М		1.05			0.041	
N		0.81			0.032	
0		0.38			0.015	

#### **Case Materials**

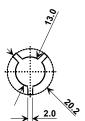
Materials				
Solder Pad Plating	0.3 to 1.0 μm Gold over 1.27 to 8.89 μm Nickel			
Lid Plating	2.0 to 3.0 µm Nickel			
Body	Al <sub>2</sub> O <sub>3</sub> Ceramic			
Pb Free				

# **TOP VIEW BOTTOM VIEW** В-C -5 2 Ĭ 3 ← D →

### **Tape and Reel Specifications**



•	'B"	Quantity Per Reel
Inches	millimeters	Quantity Fer Reer
7	178	500
13	330	3000



### **COMPONENT ORIENTATION and DIMENSIONS**

Carrier Tape Dimensions				
Ao	3.35 mm			
Во	3.35 mm			
Ko	1.40 mm			
Pitch	8.0 mm			
W	12.0 mm			

